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74AVC16374

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

Rev. 3 — 16 August 2013

Product data sheet

1. General description

The 74AVC16374 is a 16-bit edge triggered flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. The 74AVC16374 consist of 2 sections of 8 edge-triggered flip-flops. A clock input (CP) and an output enable (\overline{OE}) are provided per 8-bit section.

The 74AVC16374 is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance output state during power-up or power-down, nOE should be tied to VCC through a pull-up resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient (see Figure 5 and Figure 6).

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-1A (2.7 V to 3.6 V)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple V_{CC} and GND pins to minimize noise and ground bounce
- Supports Live Insertion

3. Ordering information

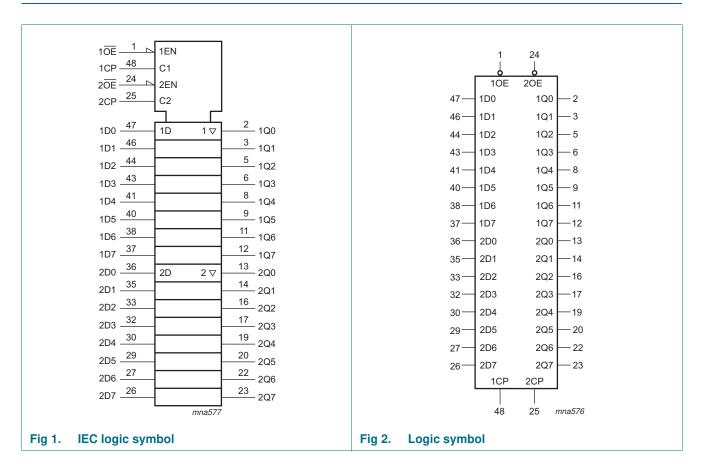
Table 1. Ordering information

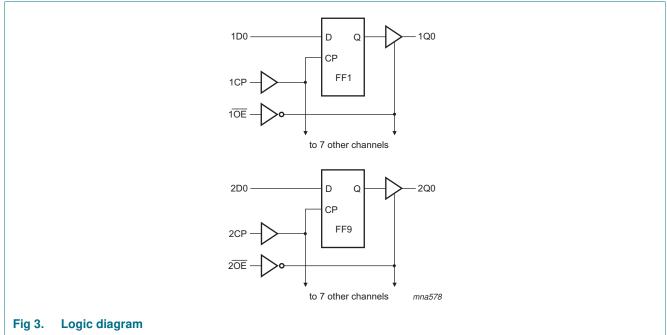
Type number	Package							
	Temperature range	Name	Description	Version				
74AVC16374DGG	–40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1				



16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

4. Functional diagram

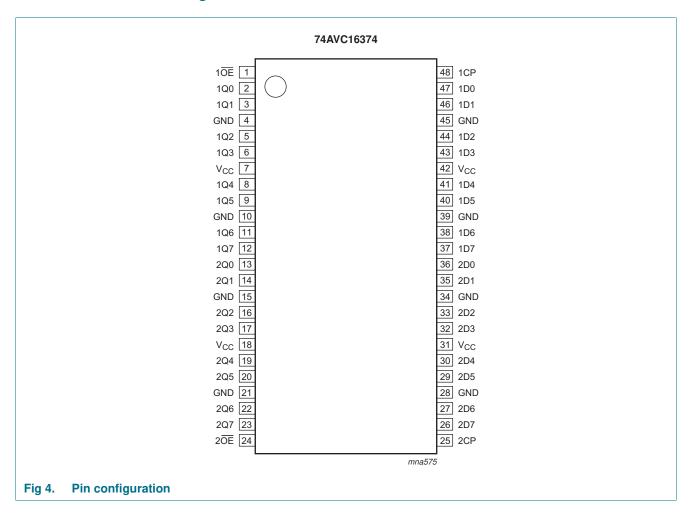




16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

5. Pinning information

5.1 Pinning



16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

5.2 Pin description

Table 2. Pin description

	· · · · · · · · · · · · · · · · · · ·	
Symbol	Pin	Description
1 OE	1	output enable input (active LOW)
1Q0 to 1Q7	2, 3, 5, 6, 8, 9, 11, 12	3-state flip-flop outputs
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
2Q0 to 2Q7	13, 14, 16, 17, 19, 20, 22, 23	3-state flip-flop outputs
2 OE	24	output enable input (active LOW)
2CP	25	clock input
2D0 to 2D7	36, 35, 33, 32, 30, 29, 27, 26	data input/output
1D0 to 1D7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
1CP	48	clock input

6. Functional description

Table 3. Function table[1]

Operating modes	Inputs			Internal flip-flops	Outputs
	nOE	nCp	nDn		nQn
Load and read register	L	\uparrow	l	L	L
	L	↑	h	Н	Н
Load register and disable outputs	Н	↑	I	L	Z
	Н	↑	h	Н	Z

^[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

I = I OW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

 $[\]uparrow$ = LOW-to-HIGH CP transition

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	$V_I < 0 V$	_	-50	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	output HIGH or LOW	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[1]</u> –0.5	+4.6	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	[2] _	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage	according to JEDEC Low Voltage Standards	1.4	-	1.6	V
			1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
V_{I}	input voltage		0	-	3.6	V
Vo	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	3.6	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall	V _{CC} = 1.4 V to 1.6 V	0	-	40	ns/V
	rate	V _{CC} = 1.65 V to 2.3 V	0	-	30	ns/V
		$V_{CC} = 2.3 \text{ V to } 3.0 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] Above 60 °C, the value of Ptot derates linearly with 5.5 mW/K.

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9. Static characteristics

Table 6. Static characteristics

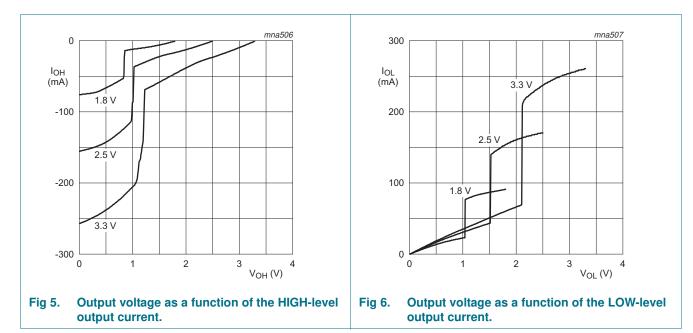
At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$T_{amb} = -$	40 °C to +85 °C					
V_{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	V_{CC}	-	-	V
		V _{CC} = 1.4 V to 1.6 V	$0.65 \times V_{CC}$	0.9	-	V
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	0.9	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	1.5	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.2 V	-	-	GND	V
		V _{CC} = 1.4 V to 1.6 V	-	0.9	$0.35 \times V_{CC}$	V
		V _{CC} = 1.65 V to 1.95 V	-	0.9	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	1.2	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	1.5	0.8	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -100 \mu A$; $V_{CC} = 1.65 V$ to 3.6 V	$V_{CC}-0.20$	V_{CC}	-	V
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	$V_{CC}-0.35$	$V_{CC}-0.23$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.45$	$V_{CC}-0.25$	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.55$	$V_{CC}-0.38$	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.70$	$V_{CC}-0.48$	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 100 \mu A$; $V_{CC} = 1.65 V$ to 3.6 V	-	GND	0.20	V
		$I_O = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	0.10	0.35	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	0.10	0.45	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.26	0.55	V
		$I_O = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.36	0.70	V
II	input leakage current	per pin; $V_I = V_{CC}$ or GND; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	0.1	2.5	μА
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 3.6 \text{ V}$; $V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND				
		$V_{CC} = 1.4 \text{ V to } 2.7 \text{ V}$	-	0.1	5	μΑ
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	0.1	10	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A				
		$V_{CC} = 1.4 \text{ V to } 2.7 \text{ V}$	-	0.1	20	μА
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	0.2	40	μА
Cı	input capacitance		-	5	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

9.1 Graphs



10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). $t_r = t_f \le 2$ ns. For test circuit, see <u>Figure 10</u>.

Symbol	Parameter	Conditions		-40	°C to +85	5 °C	Unit
					Typ[2]	Max	
t _{pd}	propagation delay	nCP to nQn; see Figure 7	<u>[1]</u>		'		'
		V _{CC} = 1.2 V		-	3.1	-	ns
		V _{CC} = 1.4 V to 1.6 V		1.2	2.4	8.4	ns
		V _{CC} = 1.65 V to 1.95 V		1.0	2.0	6.7	ns
		V _{CC} = 2.3 V to 2.7 V		8.0	1.5	4.1	ns
		V _{CC} = 3.0 V to 3.6 V		0.7	1.3	3.3	ns
t _{en}	enable time	nOE to nQn, nBn; see Figure 8	<u>[1]</u>				
		V _{CC} = 1.2 V		-	5.4	-	ns
		V _{CC} = 1.4 V to 1.6 V		1.6	3.9	8.5	ns
		V _{CC} = 1.65 V to 1.95 V		2.3	3.3	6.7	ns
		V _{CC} = 2.3 V to 2.7 V		0.9	2.3	4.3	ns
		V _{CC} = 3.0 V to 3.6 V		0.7	2.0	3.4	ns
t _{dis}	disable time	nOE to nQn; see Figure 8	[1]				
		V _{CC} = 1.2 V		-	5.6	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.5	4.5	9.4	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.8	3.3	7.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	1.8	4.2	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.2	2.0	3.9	ns

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). $t_r = t_f \le 2$ ns. For test circuit, see <u>Figure 10</u>.

Symbol	Parameter	Conditions		-40 °C to +8	5 °C	Unit
			Mir	Typ[2]	Max	
w	pulse width	HIGH; nCP; see Figure 7	'			
		V _{CC} = 1.2 V	-	0.8	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	0.5	-	ns
		V _{CC} = 1.65 V to 1.95 V	3.1	0.3	-	ns
		V_{CC} = 2.3 V to 2.7 V	2.5	0.2	-	ns
		V_{CC} = 3.0 V to 3.6 V	2.5	0.2	-	ns
su	set-up time	nDn to nCP; see Figure 8				
		V _{CC} = 1.2 V	-	-0.6	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	2.7	-0.3	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.9	-0.3	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.4	-0.2	-	ns
		V_{CC} = 3.0 V to 3.6 V	1.4	-0.1	-	ns
h	hold time	nDn to nCP; see Figure 8				
		V _{CC} = 1.2 V	-	0.8	-	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	1.3	0.7	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.2	0.6	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.1	0.5	-	ns
		V _{CC} = 3.0 V to 3.6 V	1.1	0.4	-	ns
max	maximum frequency	see Figure 8				
		V _{CC} = 1.2 V	-	250	-	MHz
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	300	-	MHz
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	160	320	-	MHz
		V_{CC} = 2.3 V to 2.7 V	200	350	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	200	350	-	MHz
C _{PD}	power dissipation	per input; $V_I = GND$ to V_{CC}	[3]			
	capacitance	outputs enabled	-	66	-	рF
		outputs disabled	-	1	-	рF

 $[\]begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$

- [2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

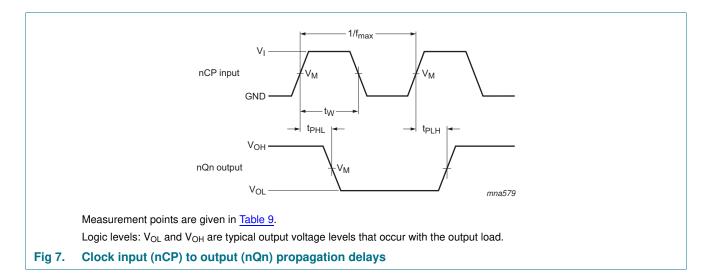
V_{CC} = supply voltage in Volts

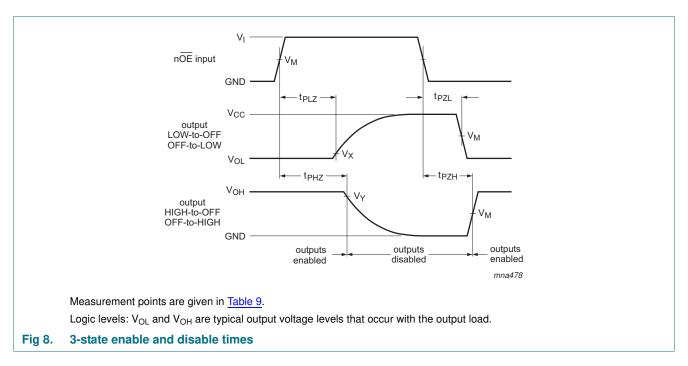
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

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11. Waveforms





16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

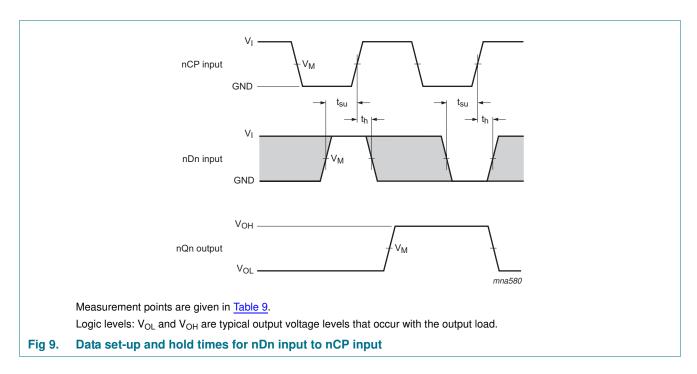
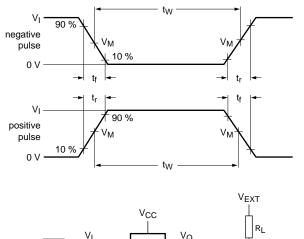
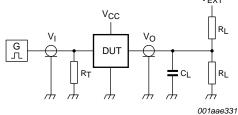


Table 8. Measurement points

Supply voltage	V _M	Input	Input				
V _{CC}		VI	$t_r = t_f$	V _X	V _Y		
1.2 V	$0.5 \times V_{\text{CC}}$	V _{CC}	≤ 2 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$		
1.4 V to 1.6 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$		
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$		
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$		
3.0 V to 3.6 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2 ns	$V_{OL} + 0.3 V$	$V_{OH}-0.3\ V$		

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		V _{EXT}		
	V _I	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t_{PLZ},t_{PZL}	t_{PHZ},t_{PZH}
1.2 V	V_{CC}	≤ 2 ns	15 pF	$2 \text{ k}\Omega$	open	$2\times V_{CC}$	GND
1.4 V to 1.6 V	V_{CC}	≤ 2 ns	15 pF	2 kΩ	open	$2\times V_{CC}$	GND
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND
3.0 V to 3.6 V	V_{CC}	≤ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND

74AVC16374

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

12. Package outline

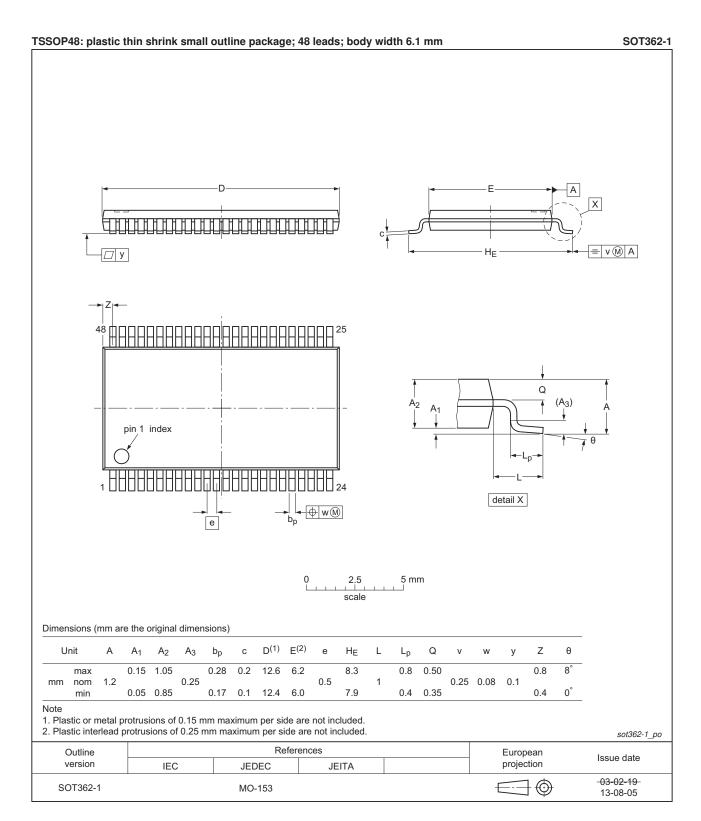


Fig 11. Package outline SOT362-1 (TSSOP48)

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16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes		
74AVC16374 v.3	20130816	Product data sheet	-	-	74AVC16374 v.2		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 						
74AVC16374 v.2	20000309	Product specification	-	-	74AVC16374 v.1		
74AVC16374 v.1	19981211	Product specification	-	-	-		

16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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16-bit edge triggered D-type flip-flop; 3.6 V tolerant; 3-state

17. Contents

1	General description
2	Features and benefits
3	Ordering information
4	Functional diagram
5	Pinning information
5.1	Pinning
5.2	Pin description
6	Functional description
7	Limiting values
8	Recommended operating conditions
9	Static characteristics 6
9.1	Graphs
10	Dynamic characteristics
11	Waveforms
12	Package outline
13	Abbreviations
14	Revision history
15	Legal information
15.1	Data sheet status
15.2	Definitions14
15.3	Disclaimers
15.4	Trademarks15
16	Contact information
17	Contents 16

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